6 Irradiation tests

major purpose: monitoring of (oxidation) process - Processing changes may affect post-irradiation performance which may not be apparent from pre-irradiation measurements

Samples:

3baby detectors (1x1 cm²) from each lot (lot=30~40 good sensors) full size detectors from initial lots and at modifications in processing some modules : using B-class sensors, if needed

Baby and full size detectors are glued on ceramic boards Proton fluence: $3 \times 10^{14} \text{ p/cm}^2$ (cf $1.4 \times 10^{14} \text{ n/cm}^2$ in 10 LHC years) Detectors are kept at -10^{0} C

measurements: I-V (I <1mA@350V and @-10^oC) C-V (Vb up to 350V and @-10^oC) Oxide puchthroughs (Ccp probing @RT) Data run and Laser scan for full-size detectors and modules @-10^oC (w/ chips→ noise, charge collection efficiency)

time estimates:

6000/(30lot)x(3/lot)/12

sample preparation: ~50 baby setsx(glue + w.b.) =150h=18d ~20?full-size detectorsx(glue + w.b.) =60h= 8d ~20? detectors x (chip mounting after irrad) =60h= 8d

measurements: I-V and C-V	$2hr/sample = 140h=17d \times 2 (pre/post)$
Сср	$2hr/sample = 140h=17d \times 2$ (pre/post)
Noise (data run)	2hr/sample = 40h=5d
Laser scan	3hr/sample = 60h=8d

